

30-02UYC/S599

Benefits

- . Fewer LEDs Required
- . Lowers Lighting System Cost
- . Viewing angle 50°

Features

- . High Flux Output.
- . Designed for High Current Operation.
- . Low Thermal Resistance.
- . Low Profile.
- . Packaged in Tubes for Use with Automatic Insertion Equipment.
- . The product itself will remain within RoHS compliant version
- . ESD-withstand voltage: up to 4KV



Descriptions

This revolutionary package design allows the light designer to reduce the number of LEDs required and provide a more uniform and unique illuminated appearance than with other LED solutions. This is possible through the efficient optical package design and high-current capabilities.

The low profile package can be easily coupled with reflectors or lenses to efficiently distribute light and provide the desired light appearance.

Applications

- . Automotive Exterior Lighting
- . Electronic Signs and Signals
- . Special Lighting application

Device Selection Guide

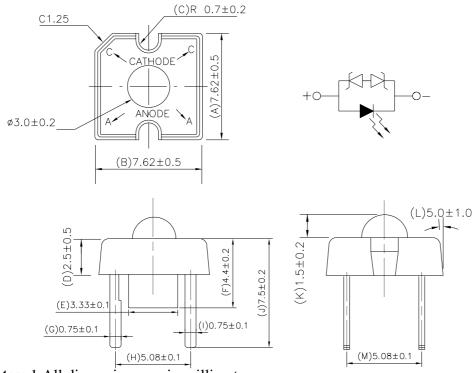
D. DELVO	C		
PART NO.	Material	Emitted Color	Lens Color
30-02UYC/S599	AlGaInP	Yellow	Water Clear

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Package Dimensions



Notes: 1.All dimensions are in millimeters

- 2.An epoxy meniscus may extend about 1.5mm(0.059") down the leads
- 3.Tolerances unless dimensions ±0.25mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units
Continuous Forward Current	I_{F}	150	mA
Peak Forward Current(Duty 1/10 @ 1KHZ)	I_{FP}	200	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{stg}	-55 ~ +100	$^{\circ}\mathbb{C}$
Soldering Temperature(T=5 sec)	T_{sol}	260 ± 5	$^{\circ}\mathbb{C}$
LED Junction Temperature	$T_{\rm j}$	125	$^{\circ}\mathbb{C}$
Power Dissipation	P_d	400	mW
Electrostatic Discharge	ESD	4K	V

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Device number: DLE-320-002

Established date: 06-22-2007

Established by: Jim Lin



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Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Condition	Unit
Total Flux	Фи	9000	11000	18000	I _F =150mA	mlm
Viewing Angle	2 θ 1/2		50		I _F =150mA	deg
Peak Wavelength	λр		591		I _F =70mA	nm
Dominant Wavelength	λd	585.5	590	594.5	I _F =70mA	nm
Spectrum Radiation Bandwidth	Δλ		15		I _F =70mA	nm
Forward Voltage	VF	1.9	2.3	2.9	I _F =150mA	V
Reverse Current	IR			10	V _R =10V	uA

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(1)	(2)	(2)
(1)	11 / 11	(1
N I J	(4 /	() /

	(1) VF(V))	(2) $\lambda d(nm)$		$(3)\Phi v(mlm)$		n)	
Bin	Min	Max	Bin	Min	Max	Bin	Min	Max
L	1.9	2.1	2	585.5	587.0	U	9000	11250
M	2.1	2.3	3	587.0	588.5	V	11250	14250
N	2.3	2.5	4	588.5	590.0	W	14250	18000
P	2.5	2.7	5	590.0	591.5			
Q	2.7	2.9	6	591.5	593.0			
			7	593.0	594.5			

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^{*}Measurement Uncertainty of Forward Voltage: ±0.1V

^{*}Measurement Uncertainty of Luminous Intensity: ±15%

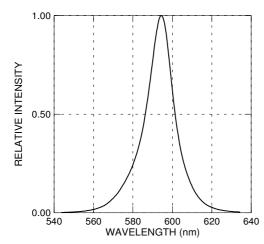
^{*}Measurement Uncertainty of Dominant Wavelength ±1.0nm



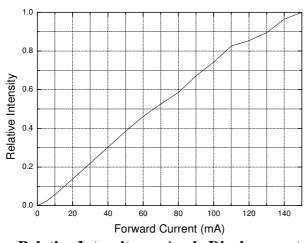
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Typical Electro-Optical Characteristics Curves

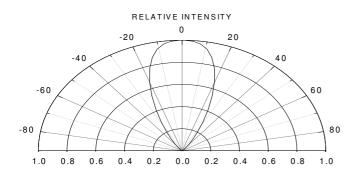
Relative Intensity vs. Wavelength



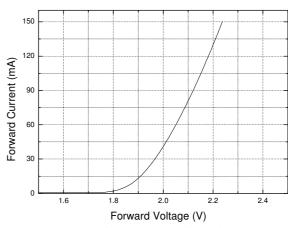
Relative Intensity vs. Forward Current



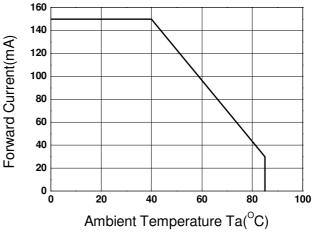
Relative Intensity vs. Angle Displacement



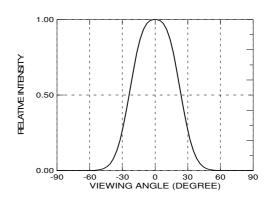
Forward Current vs. Forward Voltage



Forward Current vs. Ambient Temp.



Relative Intensity vs. Off Axis Angle



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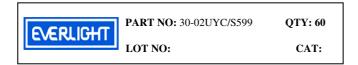
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Packing Quantity Specification

- (1) 60 pcs/1 tube, 30 tubes/1 small inside box, 12 small inside boxes/1 outside box
- (2) 60 pcs/1 tube, 105 tubes/1 big inside box, 4 big inside boxes/1 outside box

Label Form Specification

(1)Tube Label Form



(2)Box Label Form

EVERLIGHT	
CPN:	
P/N:	
	_{RoHS}
30-02UYC/S599	
QTY:	CAT:
	HUE:
LOT NO:	REF:
MADE IN TAIWAN	N

PART NO: Everlgiht's Production Number

QTY: Packing Quantity LOT NO: Lot Number

CAT: Ranks of Forward Voltage, Dominant Wavelength and Total Flux

CPN: Customer's Production Number

P/N: Production Number

HUE: Reference REF: Reference

MADE IN TAIWAN: Production Place

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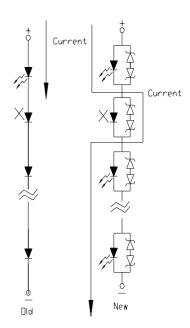
Device number: DLE-320-002 Established date: 06-22-2007 Established by: Jim Lin



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Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.
- 4. Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- 5. When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode, if either piece of LED is no light up but current can flow through causing others to light.



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6. Soldering Condition

Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to case, and soldering beyond the base of the tie bar is recommended.

Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

Recommended soldering conditions:

Hand	Soldering	DIP Soldering		
Temp. at tip of iron	400°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp.	265 Max.	
Distance	3mm Min.(From solder	Bath time.	5 sec Max.	
	joint to case)			
		Distance	3mm Min.	

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